LINQALLOY **Sn63Pb37**Eutectic Solder Spheres



Alloy Composition: Sn63Pb37Eutectic temperature: 183°C

LINQALLOY Sn63Pb57 eutectic solder spheres are lead-free Bismuth-Tin alloys that contain 63% Tin (Sn), 37% Lead (Pb) and are often written as Sn63Balance or Pb37Sn63. These solder Spheres are medium-temperature, lead-containing, eutectic solder spheres and are used by companies working with BGA and CSP components who have not made the transition to Lead-free (Pb-free) soldering.

Alloy composition

Element	Sn	Pb	Ag	Cu	As	Fe	Sb	Cd	Zn	Al	Bi
(% wt)	63	BL	0.1	0.03	0.03	0.02	0.05	0.002	0.001	0.001	0.03

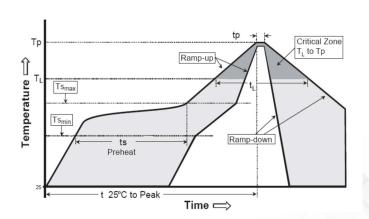
Tolerance

Diameters (mm)	Tolerance (mm)
0.500 - 0.760	±0.020
0.270 - 0.450	±0.010
0.150 - 0.250	±0.005

Reflow profile

Please refer to the supplier temperature tolerances of your components and circuit boards. Please adjust the reflow profile to your process and application parameters.

Profile	Value			
Ramp up	3°C / sec			
Preheat Temp (Ts)	100 - 150 °C			
Preheat time (ts)	60 - 120 sec			
Peak Temp (Tp)	220 - 225 °C			
Time ~5°C of Tp (tp)	10 - 30 sec			
Ramp down	6°C / sec			
25°C to Tp	6 min (max)			



Storage and Handling

Shelf life of the sealed ESD container at 25°C is 12 months. Ideal humidity is <60%RH. Touching the spheres can lead to contamination and distortion of their shape and surface due to applied pressure and skin oils. Please handle with care.

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